

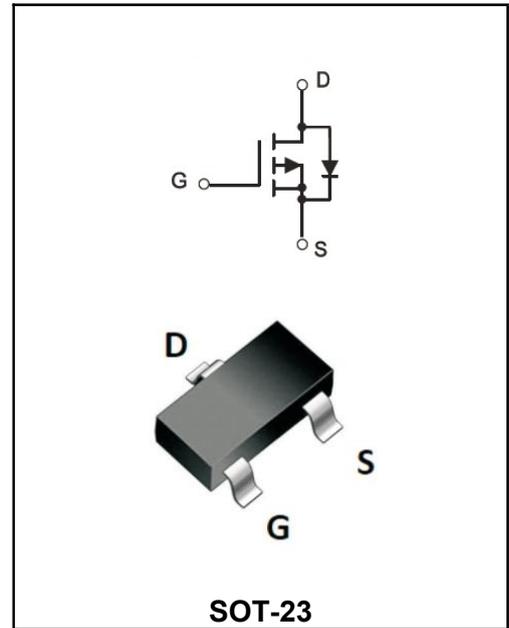
**-20V P-CHANNEL ENHANCEMENT MODE MOSFET**

**MAIN CHARACTERISTICS**

$I_D$	-7A
$V_{DSS}$	-20V
$R_{DS(on)-typ}(@V_{GS}=-4.5V)$	< 25mΩ ( <b>Type:20 mΩ</b> )

**Application**

- ◆ Quick charge
- ◆ electronic cigarette
- ◆ Uninterruptible power supply



**Marking Code**

YFW2307A	2307A
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**Maximum Ratings at Tc=25°C unless otherwise specified**

Characteristics	Symbols	Value	Units
Drain-Source Voltage	$V_{DS}$	-20	V
Gate - Source Voltage	$V_{GS}$	± 12	V
Continuous Drain Current, $V_{GS} @ -4.5V^1 @T_A=25^\circ C$	$I_D$	-7	A
Continuous Drain Current, $V_{GS} @ -4.5V^1 @T_A=70^\circ C$	$I_D$	-4.8	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	-23.8	A
Total Power Dissipation <sup>3</sup> @ $T_A=25^\circ C$	$P_D$	2	W
Storage Temperature Range	$T_{STG}$	-55 to +150	°C
Operating Junction Temperature Range	$T_J$	-55 to +150	°C
Thermal Resistance Junction-Ambient <sup>1</sup>	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance Junction-Case <sup>1</sup>	$R_{\theta JC}$	80	°C/W

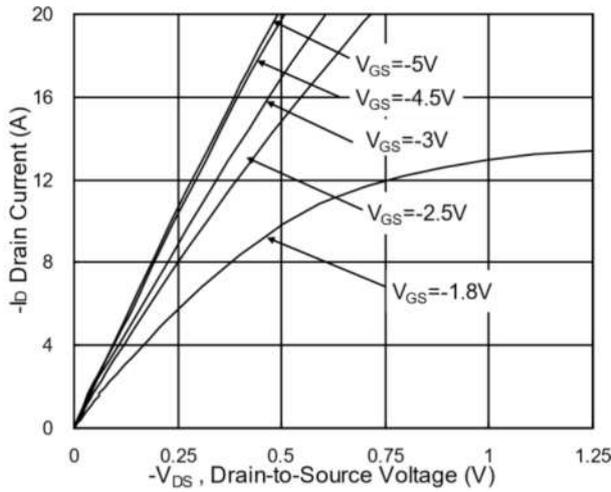
**Maximum Ratings at Tc=25°C unless otherwise specified**

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	<b>V(BR)DSS</b>	-20	-22	-	<b>V</b>
Zero Gate Voltage Drain Current	$V_{DS}=-20V, V_{GS}=0V$	<b>I<sub>DSS</sub></b>	-	-	1	<b>μA</b>
Gate to Body Leakage Current	$V_{GS}=\pm 12V, V_{DS}=0V$	<b>I<sub>GSS</sub></b>	-	-	±100	<b>nA</b>
Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	<b>V<sub>GS(th)</sub></b>	-0.5	-0.7	-1.2	<b>V</b>
Static Drain-Source on-Resistance note2	$V_{GS}=-4.5V, I_D=-6A$	<b>R<sub>DS(ON)</sub></b>	-	20	25	<b>mΩ</b>
	$V_{GS}=-2.5V, I_D=-5A$		-	28	35	
Input Capacitance	$V_{DS}=-10V$ $V_{GS}=0V$ $f=1MHz$	<b>C<sub>iss</sub></b>	-	2000	-	<b>pF</b>
Output Capacitance		<b>C<sub>oss</sub></b>	-	242	-	
Reverse Transfer Capacitance		<b>C<sub>rss</sub></b>	-	231	-	
Total Gate Charge	$V_{DS}=-10V$ $V_{GS}=-4.5V$ $I_D=-3A$	<b>Q<sub>g</sub></b>	-	15.3	-	<b>nC</b>
Gate-Source Charge		<b>Q<sub>gs</sub></b>	-	2.2	-	
Gate-Drain("Miller") Charge		<b>Q<sub>gd</sub></b>	-	4.4	-	
Turn-on delay time	$V_{DD}=-10V$ $V_{GS}=-4.5V$ $I_D=-7A$ $R_{GEN}=2.5\Omega$	<b>t<sub>d(on)</sub></b>	-	10	-	<b>ns</b>
Turn-on Rise Time		<b>T<sub>r</sub></b>	-	31	-	
Turn-Off Delay Time		<b>t<sub>d(OFF)</sub></b>	-	28	-	
Turn-Off Fall Time		<b>t<sub>f</sub></b>	-	8	-	
Maximum Continuous Drain to Source Diode Forward Current		<b>I<sub>S</sub></b>	-	-	-7	<b>A</b>
Maximum Pulsed Drain to Source Diode Forward Current		<b>I<sub>SM</sub></b>	-	-	-28	<b>A</b>
Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S=-7A$	<b>V<sub>SD</sub></b>	-	-0.8	-1.2	<b>V</b>

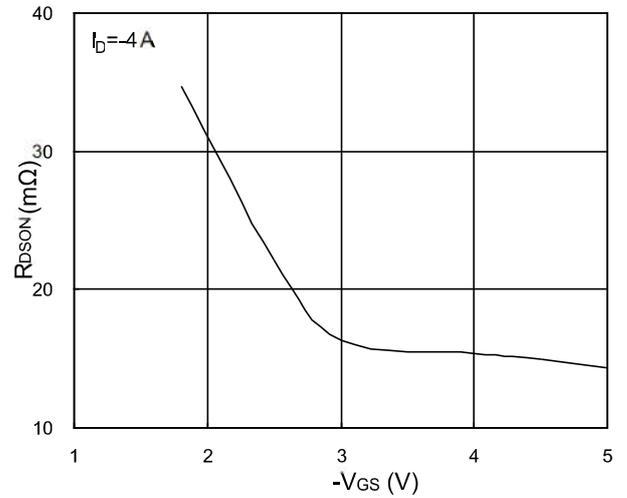
Note :

- 1、 The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width  $\cong 300\mu s$  , duty cycle  $\cong 2\%$
- 3、 The power dissipation is limited by 150°C junction temperature
- 4、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

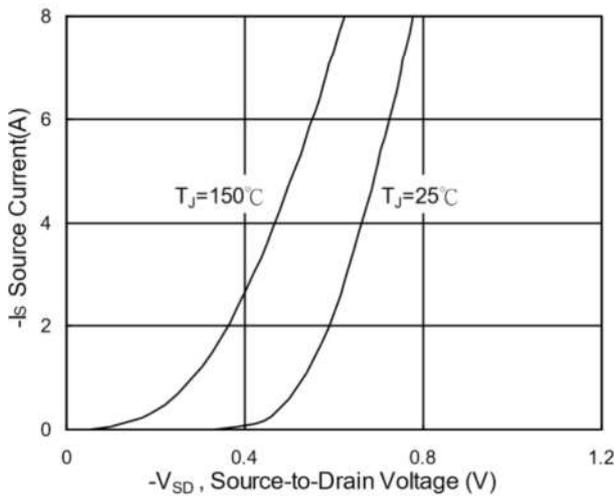
**Ratings and Characteristic Curves**



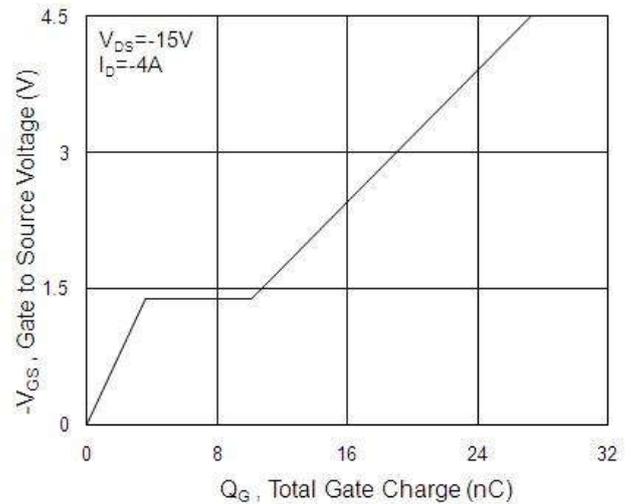
**Fig.1 Typical Output Characteristics**



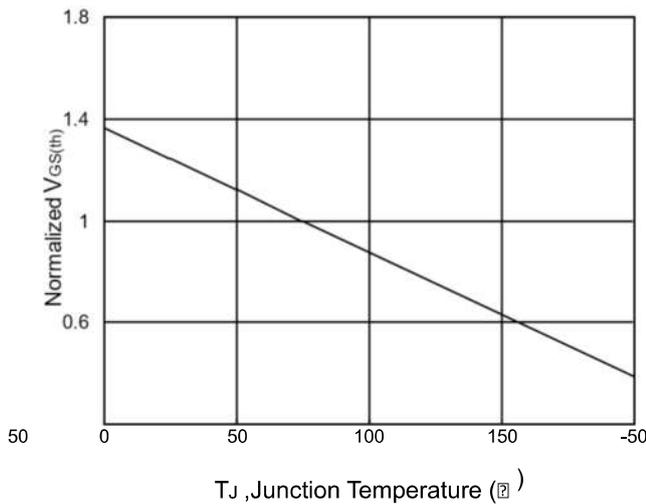
**Fig.2 On-Resistance vs. Gate-Source**



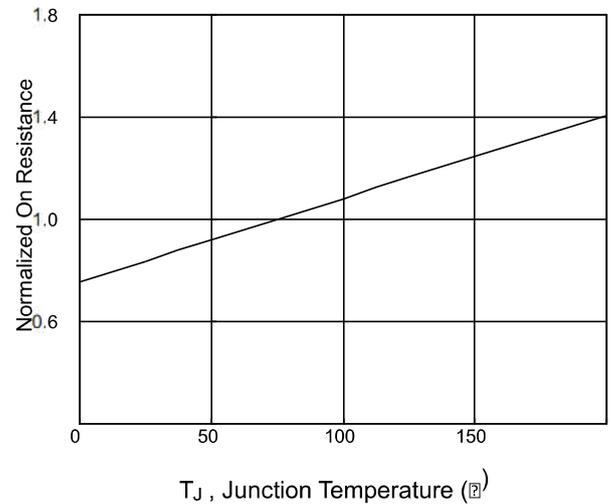
**Fig.3 Forward Characteristics Of Reverse**



**Fig.4 Gate-Charge Characteristics**



**Fig.5 Normalized VGS(th) vs. TJ**



**Fig.6 Normalized RDS(on) vs. TJ**

Ratings and Characteristic Curves

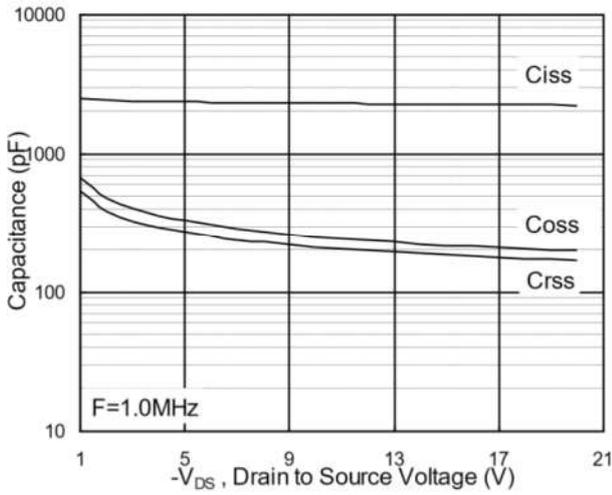


Fig.7 Capacitance

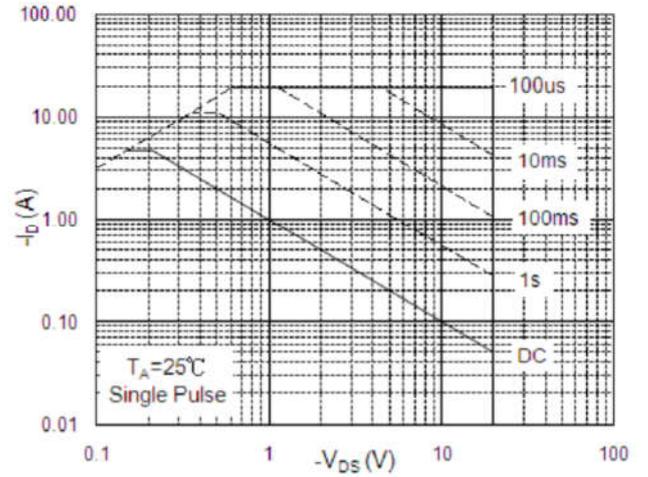


Fig.8 Safe Operating Area

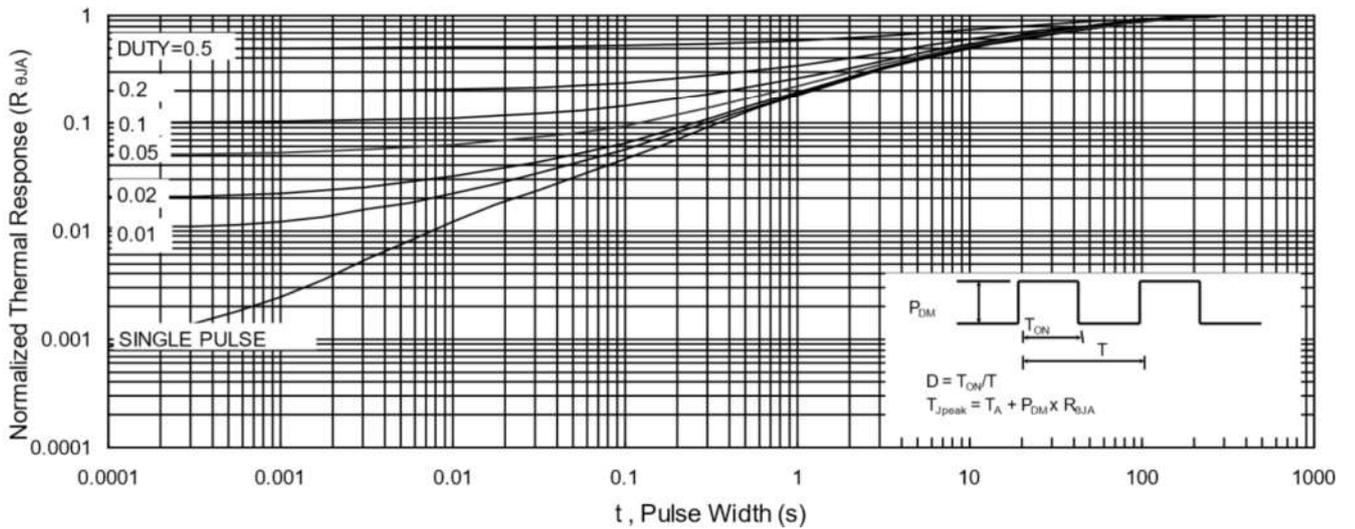


Fig.9 Normalized Maximum Transient Thermal Impedance

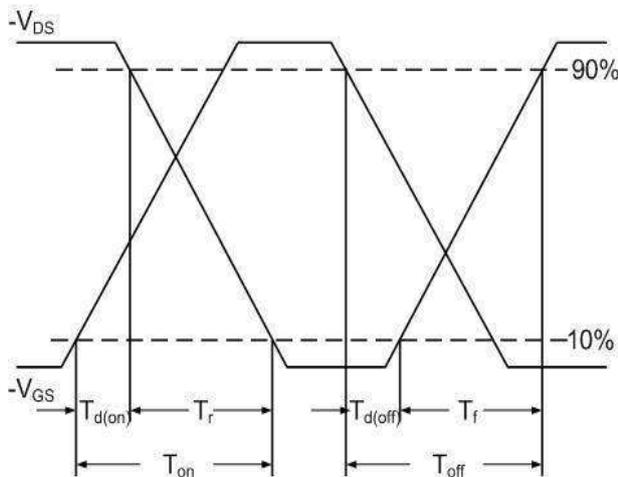


Fig.10 Switching Time Waveform

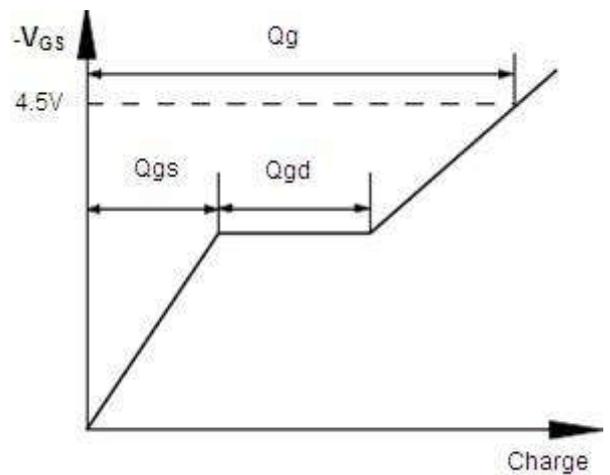


Fig.11 Gate Charge Waveform

Ordering information

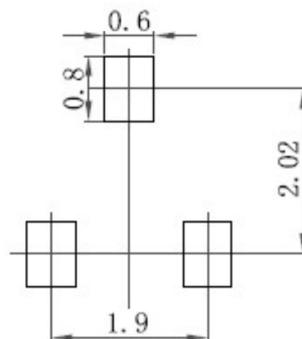
Package	Packing Description	Base Quantity	Packing Quantity
SOT-23	Tape/Reel, 7" reel	3000pcs/Reel	24000PCS/Box 120000PCS/Carton

Package Dimensions

SOT-23

Dim.	Millimeter (mm)		mil	
	Min.	Max.	Min.	Max.
A	0.9	1.15	35	45
A1	0.1		3.9	
bp	0.38	0.48	15	19
C	0.09	0.15	3.54	5.9
D	2.8	3.0	110	118
E	1.2	1.4	47	55
E	1.9		75	
E1	0.95		37	
HE	2.1	2.55	83	100
Lp	0.15	0.45	5.9	18
Q	0.45	0.55	18	22
v	0.2		7.9	
W	0.1		4	

The recommended mounting pad size



## Disclaimer

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